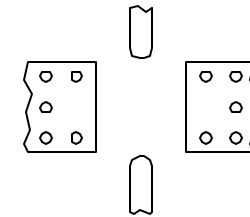
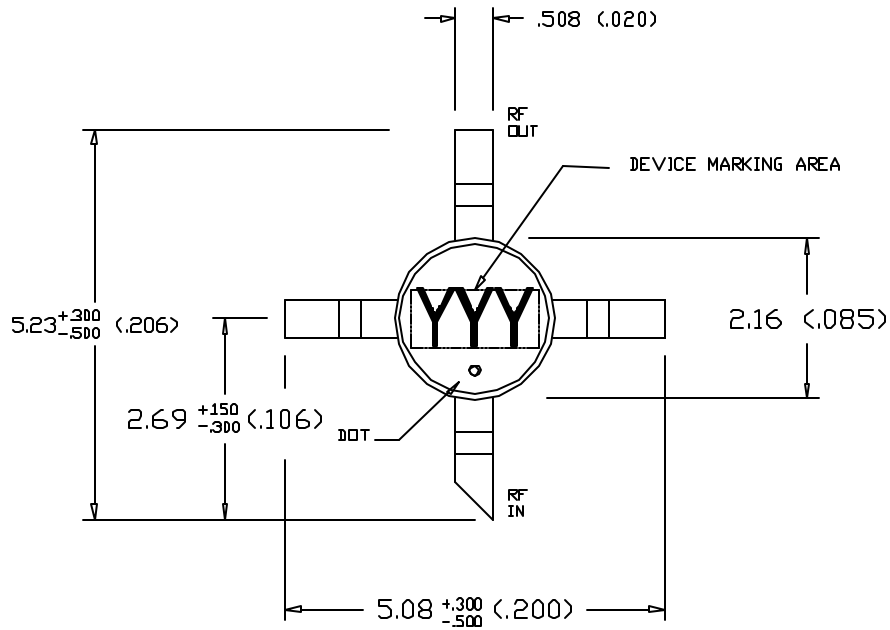
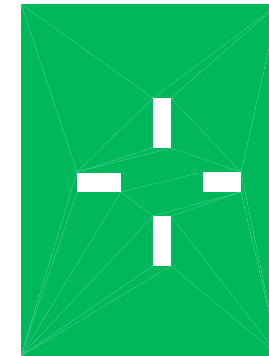
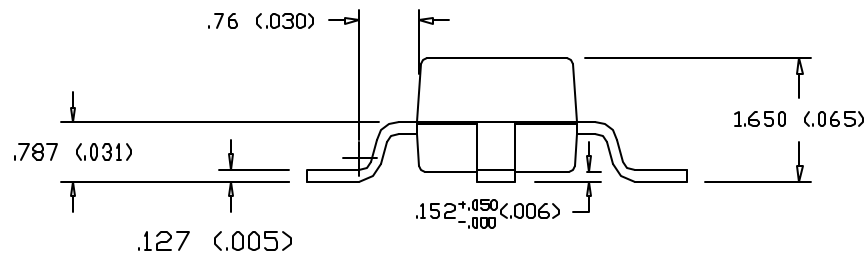


Caution: The Land Patterns and Solder Mask shown are generic for this package.  
Refer to product data sheet for any required variations specific to an application.



Scale 4:1  
- Generic Land Pattern -



Scale 4:1  
- Generic Solder Mask Opening -

UNLESS OTHERWISE SPECIFIED,  
DIMENSIONS ARE IN mm (Inches)  
PER ANSI Y14.5M-1982.

TOLERANCES ARE:  
DECIMAL ANGLE  
.XX ±.12 (.005) ±1/2°  
.XXX ±.05 (.002)

MATERIAL(S):

See Notes

FINISH:

See Notes

Notes:

1. Base Metal - Copper D119 194
2. Lead Finish  
Basic PN - Sn/Pb Sn =>80%  
Z option - 100% Matte Sn - .01 (.0004) thk min

- Do Not Scale Hard Copy -



Package Type:

SOT-86 (Micro X) 4 Id  
SMDI Package Type: XXX-XX86

Dwg No.

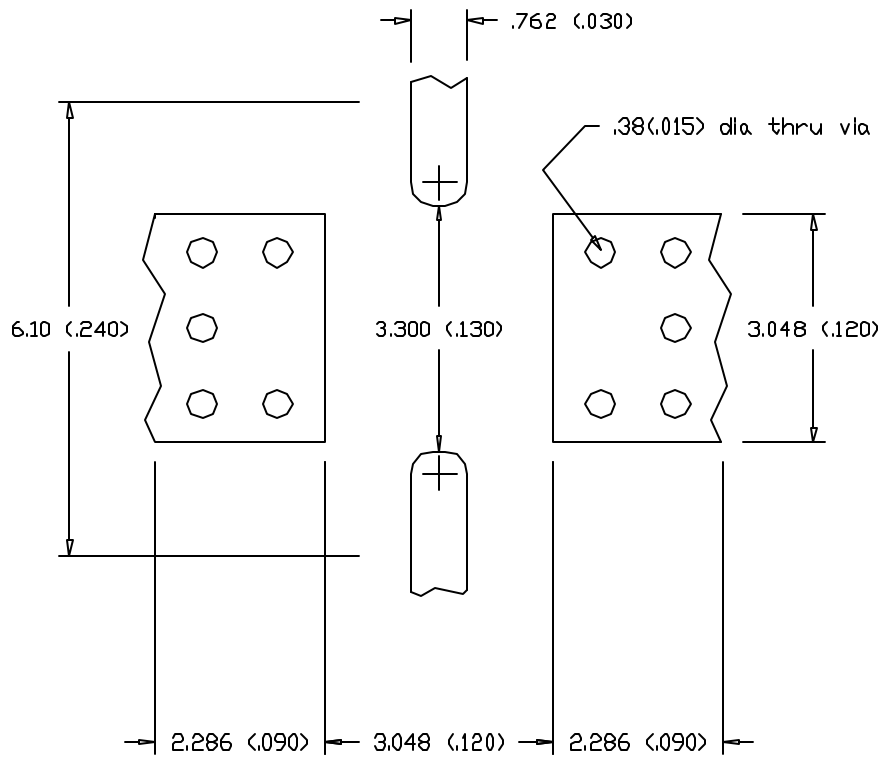
MP0-100133

Sht

1 of 2

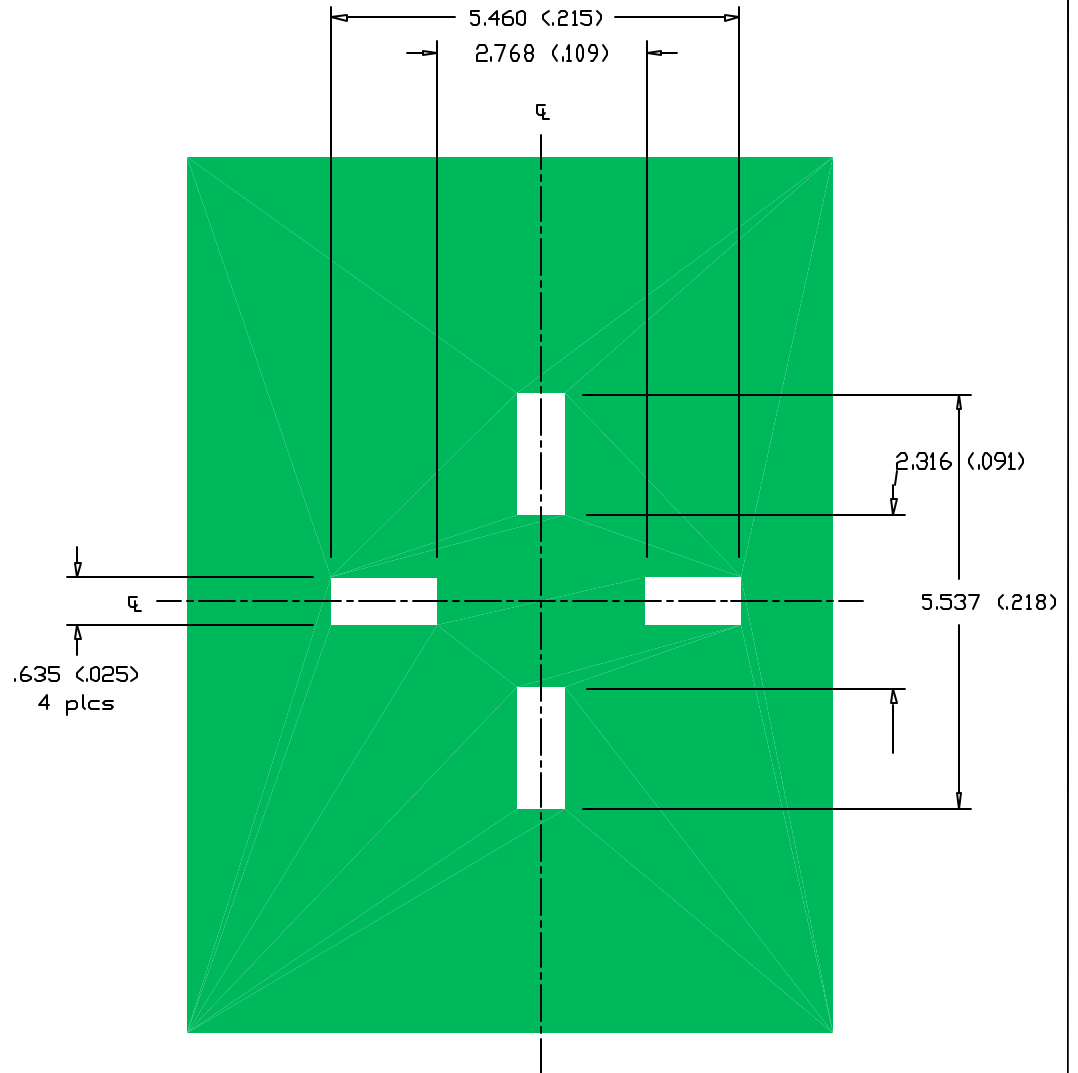
REV

C



Scale 10:1

- Generic Land Pattern -



Scale 10:1

- Generic Solder Mask Opening -

- Do Not Scale Hard Copy -

<b>SIBEDZA</b> MICRODEVICES			
Package Type: SOT-86 (Micro X) 4 Id SMDI Package Type: XXX-XX86			
Dwg No.	MP0-100133	Sht 2 of 2	REV C